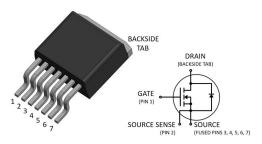
MSC360SMA120SA

1200 V, 360 mΩ SiC N-Channel Power MOSFET

Product Overview

D2PAK 7-lead Package with a Source Sense, Typ. 360 m Ω at 20 V_{GS}



Features

The following are key features of the MSC360SMA120SA device:

- · Low capacitances and low gate charge
- · Fast switching speed due to low internal gate resistance (ESR)
- Stable operation at high junction temperature, T_{J(max)} = 175 °C
- · Fast and reliable body diode
- · Superior avalanche ruggedness
- RoHS compliant

Benefits

The following are benefits of the MSC360SMA120SA device:

- · High efficiency to enable lighter, more compact system
- Simple to drive and easy to parallel
- · Improved thermal capabilities and lower switching losses
- Eliminates the need for external freewheeling diode
- Lower system cost of ownership

Applications

The MSC360SMA120SA device is designed for the following applications:

- · PV inverter, converter, and industrial motor drives
- · Smart grid transmission and distribution
- Induction heating and welding
- · H/EV powertrain and EV charger
- · Power supply and distribution

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1. Device Specifications

This section shows the specifications of the MSC360SMA120SA device.

1.1 Absolute Maximum Ratings

The following table shows the absolute maximum ratings of the MSC360SMA120SA device.

Table 1-1. Absolute Maximum Ratings

Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain source voltage	1200	V
I _D	Continuous drain current at T _C = 25 °C	12	Α
	Continuous drain current at T _C = 100 °C	8	
I _{DM}	Pulsed drain current ¹	27	
V_{GS}	Gate-source voltage	23 to -10	V
P _D	Total power dissipation at T _C = 25 °C	92	W
	Linear derating factor	0.61	W/°C

Note:

1. Repetitive rating: pulse width and case temperature limited by maximum junction temperature.

The following table shows the thermal and mechanical characteristics of the MSC360SMA120SA device.

Table 1-2. Thermal and Mechanical Characteristics

Symbol	Characteristic/Test Conditions	Min	Тур	Max	Unit
$R_{\theta JC}$	Junction-to-case thermal resistance		1.25	1.63	°C/W
T _J	Operating junction temperature	- 55		175	°C
T _{STG}	Storage temperature	- 55		150	°C
	Reflow temperature			260	°C
Wt	Package weight		0.05		oz
			1.42		g

1.2 Electrical Performance

The following table shows the static characteristics of the MSC360SMA120SA device. T_J = 25 °C unless otherwise specified.

Table 1-3. Static Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 100 \mu\text{A}$	1200			V
R _{DS(on)}	Drain-source on resistance ¹	$V_{GS} = 20 \text{ V}, I_D = 5 \text{ A}$		360	450	mΩ
V _{GS(th)}	Gate-source threshold voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.9	3.6	4.5	V

continued								
Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit		
I _{DSS}	Zero gate voltage drain current	V _{DS} = 1200 V, V _{GS} = 0 V			100	μA		
		V _{DS} = 1200 V, V _{GS} = 0 V, T _J = 125 °C			500			
I _{GSS}	Gate-source leakage current	V _{GS} = 20 V/–10 V			±100	nA		

Note:

1. Pulse test: pulse width < 380 μ s, duty cycle < 2%.

The following table shows the dynamic characteristics of the MSC360SMA120SA device. T_J = 25 °C unless otherwise specified.

Table 1-4. Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
C _{iss}	Input capacitance	V _{GS} = 0 V, V _{DD} = 1000 V, V _{AC} = 25		255		pF
C _{rss}	Reverse transfer capacitance	mV, <i>f</i> = 200 kHz		2.3		
C _{oss}	Output capacitance			28		
Qg	Total gate charge	$V_{GS} = -5 \text{ V/20 V}, V_{DD} = 800 \text{ V}, I_{D} =$		21		nC
Q_{gs}	Gate-source charge	5 A		6		
Q _{gd}	Gate-drain charge			7		
t _{d(on)}	Turn-on delay time	$V_{DD} = 820 \text{ V}, V_{GS} = -5 \text{ V}/20 \text{ V}, I_{D} =$		15		ns
t _r	Voltage rise time	10 A, $R_{g(ext)}$ = 16 Ω, Freewheeling diode = MSC360SMA120SA (V_{GS}		6		
t _{d(off)}	Turn-off delay time	= –5 V); reference Figure 1-17		12		
t _f	Voltage fall time			6		
E _{on}	Turn-on switching energy			172		μJ
E _{off}	Turn-off switching energy			15		
ESR	Gate equivalent series resistance	f = 1 MHz, 25 mV, drain short		3.7		Ω
SCWT	Short circuit withstand time	V _{DS} = 960 V, V _{GS} = 20 V		2.6		μs
E _{AS}	Avalanche energy, single pulse	V _{DS} = 150 V, I _D = 5 A		100		mJ

The following table shows the body diode characteristics of the MSC360SMA120SA device. T_J = 25 °C unless otherwise specified.

Table 1-5. Body Diode Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
V _{SD}	Diode forward voltage	I _{SD} = 5 A, V _{GS} = 0 V		4.0		V
		$I_{SD} = 5 \text{ A}, V_{GS} = -5 \text{ V}$		4.2		

continued								
Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit		
t _{rr}	Reverse recovery time	I_{SD} = 10 A, V_{GS} = -5 V, V_{DD} = 820 V, dl/dt = -7600 A/µs,		10		ns		
Q _{rr}	Reverse recovery charge	Drive Rg = 16Ω		192		nC		
I _{RRM}	Reverse recovery current			31		Α		

1.3 Typical Performance Curves

This section shows the typical performance curves of the MSC360SMA120SA device.

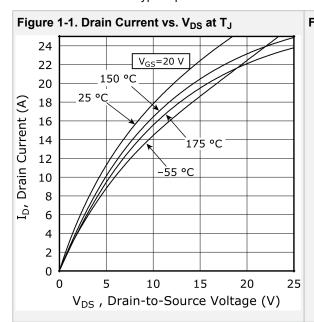
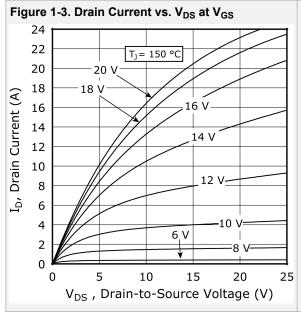
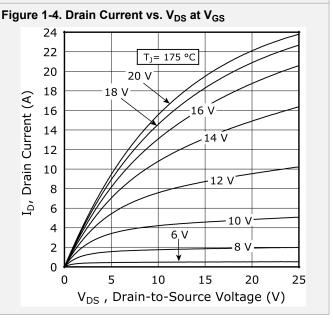


Figure 1-2. Drain Current vs. V_{DS} at V_{GS} 24 T_J = 25 °C 22 20 20 V 18 Drain Current (A) 18 V 16 14 16 V 12 10 8 ľο 6 8V 10V 10 25 V_{DS} , Drain-to-Source Voltage (V)





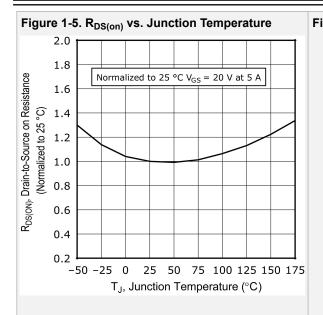
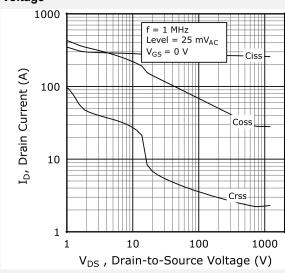
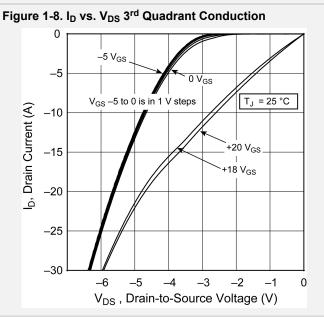
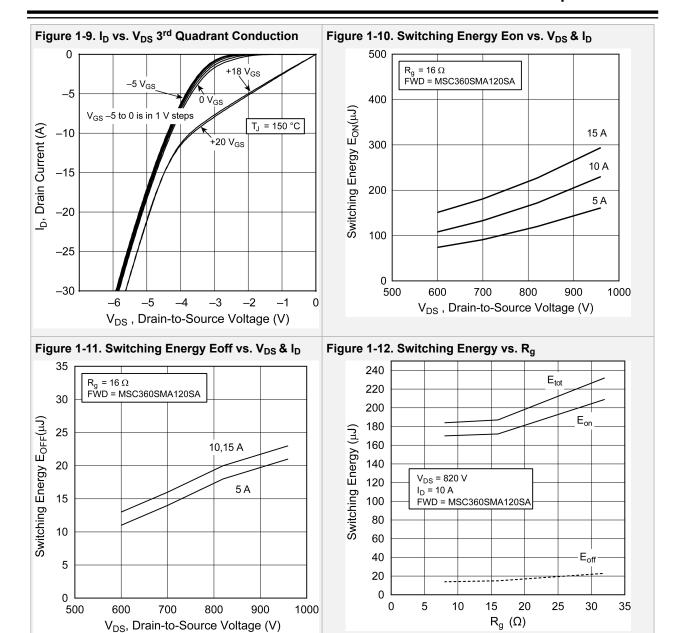


Figure 1-6. Gate Charge Characteristics $I_{GS} = 1 \text{ mA}$ V_{GS}, Gate-to-Source Voltage I_{DS} = 5 A 20 $V_{DS} = 800 \text{ V}$ 10 0 -100 5 10 15 20 25 Q_G, Gate Charge (nC)

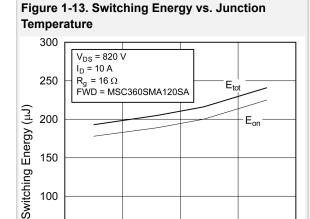
Figure 1-7. Capacitance vs. Drain-to-Source Voltage







75 100 125 150 175



150

3.5 V_{GS(th)}, Threshold Voltage (V) 3.0 2.5 $V_{GS} = V_{DS}$ $I_D = 250 \mu A$ 2.0 1.5 1.0 0.5

25 50

Junction Temperature (°C)

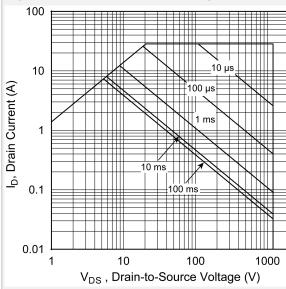
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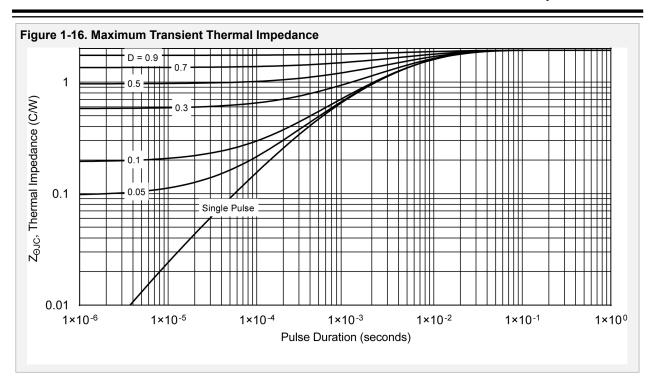
-50 -25

Figure 1-14. Threshold Voltage vs. Junction Temperature

100 50 E_{off} 0 50 100 150 200 T_J, Junction Temperature (°C)

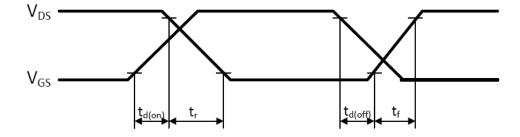






The following figure shows the switching waveform diagram of the MSC360SMA120SA device.

Figure 1-17. Switching Waveform



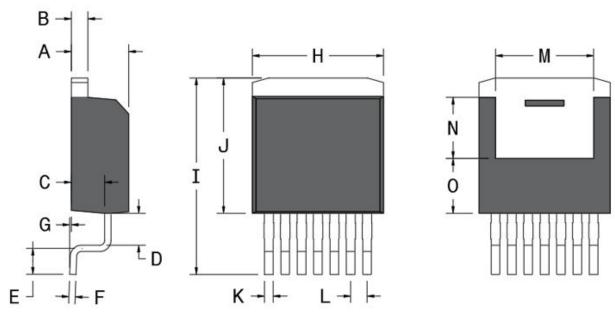
2. Package Specification

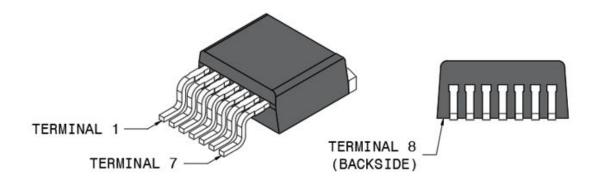
This section shows the package specification of the MSC360SMA120SA device.

2.1 Package Outline Drawing

The following figure illustrates the D2PAK 7-lead package outline of the MSC360SMA120SA device.

Figure 2-1. Package Outline Drawing





The following table shows the D2PAK 7-lead dimensions and should be used in conjunction with the package outline drawing.

Table 2-1. D2PAK Dimensions

Symbol	Min (mm)	Max (mm)	Min (in.)	Max (in.)
Α	4.30	4.57	0.169	0.180
В	1.17	1.40	0.046	0.055
С	2.50	2.70	0.098	0.106

MSC360SMA120SA

Package Specification

continu	continued						
Symbol	Min (mm)	Max (mm)	Min (in.)	Max (in.)			
D	2.85	2.95	0.112	0.116			
E	2.32	2.70	0.091	0.106			
F	0.33	0.65	0.013	0.026			
G	0.00	0.25	0.00	0.010			
Н	10.13	10.23	0.399	0.403			
I	15.04	17.12	0.592	0.674			
J	10.19	10.80	0.401	0.425			
K	0.50	0.70	0.020	0.028			
L	1.27 BSC		0.050 BSC				
М	6.78	7.67	0.267	0.302			
N	4.66	4.81	0.183	0.189			
0	4.20	4.30	0.165	0.169			
Terminal 1	Gate						
Terminal 2	Source sense						
Terminal 3	Source						
Terminal 4	Source	Source					
Terminal 5	Source	Source					
Terminal 6	Source	Source					
Terminal 7	Source						
Terminal 8	Drain						

3. Revision History

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

Table 3-1. Revision History

Revision	Date	Description
A	11/2022	Document created.

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